Docket No.

Rec'd PCT/PTO 1 6 NOV 2005

Westerman, Hattori, Daniels & Adrian LLP 10/533655 DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention **entitled**

COMPOSITE OF ALUMINUM ALLOY AND RESIN AND PRODUCTION METHOD THEREFOR

the specificati	on of which is attached hereto un	nless the following is che	ecked	
was filed of International	onas United States Applic Application Number <u>PCT/JP200</u>	ation Number and 03/14213 and was amend	was filed on November 7,20 led on(if applicable).	003as PCT
I hereby state claim(s), as an	that I have reviewed and underst nended by any amendment refer	and the contents of the a red above.	bove-identified specification	, including the
I acknowledge Regulations, §	e the duty to disclose information \$1.56.	which is material to par	tentability as defined in Title	37, Code of Federal
for patent or in	n foreign priority benefits under inventor's certificate listed below tificate having a filing date befor	and have also identified	below any foreign application	n for patent or
(T				Priority Claimed
(List prior foreign applications. See		TADARI	N 1 0 0000	
note A)	<u>2002-325244</u> (Number)	JAPAN (Country)	November 8,2002	Yes □ No
	(Nulliber)	(Country)	(Day/Month/Year Filed)	
				☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
		•	,	
				☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
				☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
(See note B)	See attached list for additional	• • • •	· •	
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in the manner information w	the benefit under Title 35, Unit subject matter of each of the clai provided by the first paragraph hich is material to patentability a pecame available between the filplication.	ms of this application is of Title 35, United State is defined in Title 37. Co	not disclosed in the prior United Code, § 112, I acknowledged of Federal Regulations.	ted States application the duty to disclose
			Stat	ús
(List prior U.S. Applications)				
Apprications	(Application Serial No.)	(Filing Date)	Patented Pend	ling Abandoned
	(Application Serial No.)	(Filing Date)	Patented Pend	ling Abandoned
	(Application Carial No.)	(Eiling Data)	Patented Pend	ling Abandoned
	(Application Serial No.)	(Filing Date)		
			☐ Patented ☐ Pend	ing Abandoned
	(Application Serial No.)	(Filing Date)		

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Customer Number: 38834

Please direct all communications to the following address:

Westerman, Hattori, Daniels & Adrian, LLP
1250 Connecticut Avenue, N.W., Suite 700, Washington, D.C. 20036

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C)	Full name of sole or Inventor's signature	first inventor (given name, family name)	Date May 6. 2005	
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- 200	Full name of second	inventor (given name, family name)	_ Naoki ANDO	
\mathcal{A}	Inventor's signature	NAOKi Andor	Date May 1. 1905	
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Tie				
9-00	Full name of third inv	ventor (given name, family name)	_Masao TAKAHASHI	
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	Residence		Citizenship	
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•	Full name of fifth inv			
	Inventor's signature		Date	
	Residence		Citizenship	
	Post Office Address			
	Full name of sixth inventor (given name, family name)			
	Inventor's signature Residence		Date	
	Post Office Address		Citizenship	
	1 05t Office Address			

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